

CLL914

**SURFACE MOUNT
HIGH SPEED SILICON
SWITCHING DIODE**



SOD-80 CASE



www.centrasemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CLL914 type is an ultra-high speed silicon switching diode manufactured by the epitaxial planar process, in a hermetically sealed glass surface mount package, designed for high speed switching applications.

MARKING: CATHODE BAND

MAXIMUM RATINGS: ($T_A=25^\circ\text{C}$)

Continuous Reverse Voltage
Peak Repetitive Reverse Voltage
Continuous Forward Current
Peak Repetitive Forward Current
Peak Forward Surge Current, $t_p=1.0\mu\text{s}$
Peak Forward Surge Current, $t_p=1.0\text{s}$
Power Dissipation
Operating and Storage Junction Temperature
Thermal Resistance

SYMBOL

V_R	75	V
V_{RRM}	100	V
I_F	250	mA
I_{FRM}	250	mA
I_{FSM}	4.0	A
I_{FSM}	1.0	A
P_D	500	mW
T_J, T_{stg}	-65 to +200	$^\circ\text{C}$
θ_{JA}	350	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS: ($T_A=25^\circ\text{C}$ unless otherwise noted)

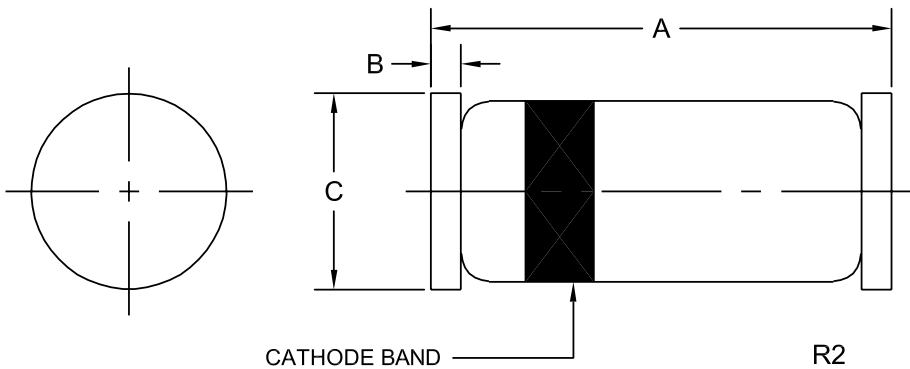
SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I_R	$V_R=20\text{V}$			25	nA
I_R	$V_R=75\text{V}$			5.0	μA
BV_R	$I_R=100\mu\text{A}$	100		V	
V_F	$I_F=10\text{mA}$			1.0	V
C_T	$V_R=0, f=1\text{ MHz}$			4.0	pF
t_{rr}	$I_R=I_F=10\text{mA}, R_L=100\Omega,$ Rec. to 1.0mA		4.0	5.0	ns

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SOD-80 CASE - MECHANICAL OUTLINE



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DIMENSIONS				
SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.130	0.146	3.30	3.71
B	0.014		0.35	
C (DIA)	0.049	0.067	1.25	1.70

SOD-80 (REV:R2)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options
- Custom bar coding for shipments
- Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities
- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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